

# 1.40mm Height Subminiature Axial Flat Top View Super Yellow Green Chip LED Technical Data Sheet

# Part No.: A21UGC-2B/TR2



#### Features:

High intensity. Wide viewing angle. General purpose leads. Mono-color type. The product itself will remain within RoHS compliant version.

# Descriptions:

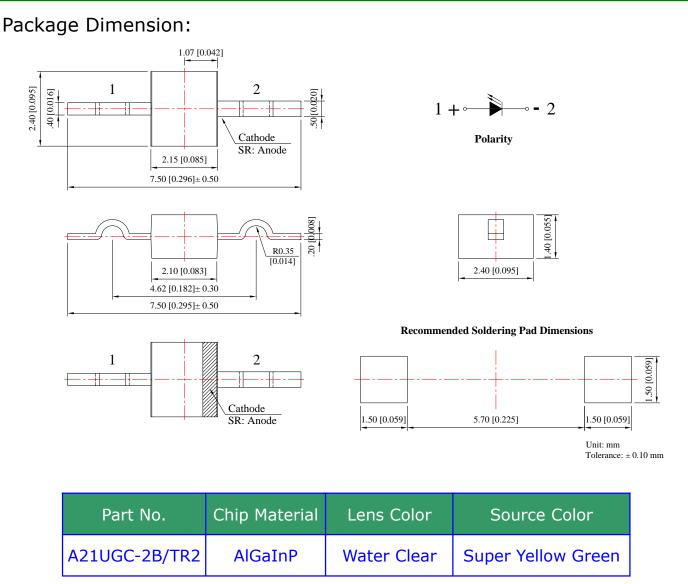
The A21 SMD taping is much smaller than leaded components. Thus enable smaller board size. Higher packing density. Reduced storage space and finally smaller equipment to be obtained.

Besides, light weight makes them ideal for miniature applications.

# Applications:

Small indicator for indoor applications. Flat backlight for LCD, switches and symbols. Indicator and backlight in office equipment. Indicator and backlight for battery driven equipment. Indicator and backlight for audio and video equipment. Automotive: Backlighting in dashboards and switches. Telecommunication: Indicator and backlighting in telephone and fax.





#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.10 mm (.004") unless otherwise specified.
- 3. Specifications are subject to change without notice.



# Absolute Maximum Ratings at Ta=25

Parameters	Symbol	Max	Unit	
Power Dissipation	PD	60	mW	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	IFP	100	mA	
Continuous Forward Current	IF	25	mA	
Reverse Voltage	VR	5	V	
Electrostatic Discharge (HBM)	ESD	2000	V	
Operating Temperature Range	Topr	-40 to +80		
Storage Temperature Range	Tstg	-40 to +85		
Soldering Temperature	Tsld	260 for 5 Seconds		

# Electrical Optical Characteristics at Ta=25

Parameters	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity *	IV	60	100		mcd	IF=20mA (Note 1)
Viewing Angle *	201/2		140		Deg	IF=20mA (Note 2)
Peak Emission Wavelength	λр		575		nm	IF=20mA
Dominant Wavelength	λd		573		nm	IF=20mA (Note 3)
Spectral Line Half-Width	λ		20		nm	IF=20mA
Forward Voltage	VF	1.60	2.00	2.40	V	IF=20mA
Reverse Current	IR			10	μA	V <sub>R</sub> =5V

#### Notes:

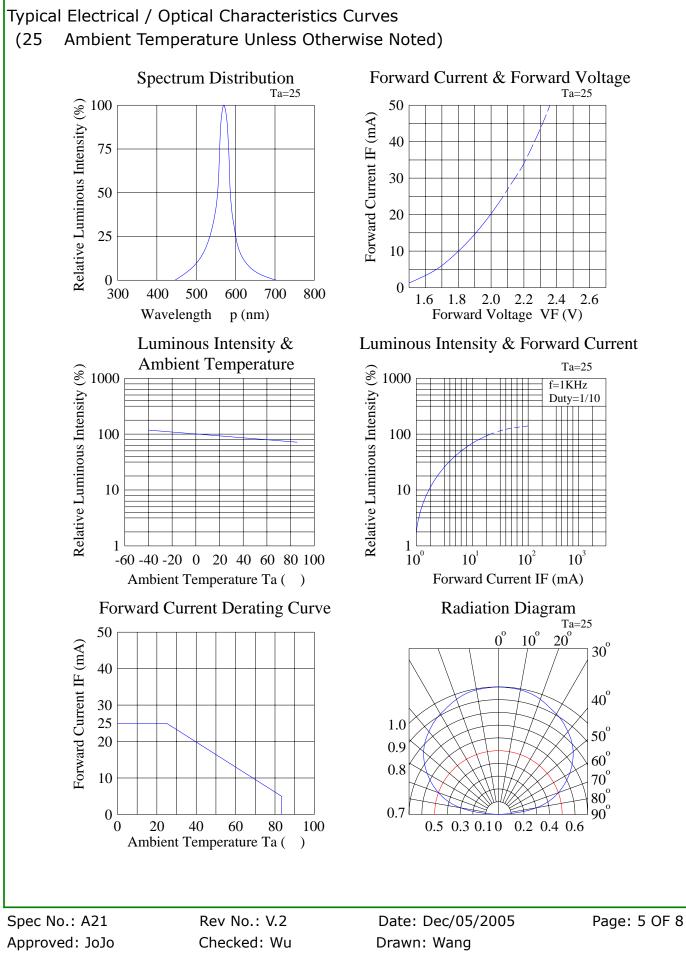
1. Luminous Intensity Measurement allowance is  $\pm$  10%.

2.  $\theta_{1/2}$  is the off-axis angle at which the luminous intensity is half the axial luminous intensity.

3. The dominant wavelength ( $\lambda d$ ) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.



Lucky Light Electronics Co., Ltd.



http://www.luckylightled.com



# Reliability Test Items And Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

## 1) Test Items and Results:

No.	Test Item	Test Hours/Cycles	Test Conditions	Sample Size	Ac/Re
1	Resistance to Soldering Heat	6 Min	Tsld=260±5 , Min. 5sec	25pcs	0/1
2	Thermal Shock	300 Cycles	H: +100 5min ∫ 10 sec L: -10 5min	25pcs	0/1
3	Temperature Cycle	300 Cycles	H: +100 15min ∫ 5min L: -40 15min	25pcs	0/1
4	High Temperature Storage	1000Hrs.	Temp: 100	25pcs	0/1
5	DC Operating Life	1000Hrs.	IF=20mA	25pcs	0/1
6	Low Temperature Storage	1000Hrs.	Temp: -40	25pcs	0/1
7	High Temperature/ High Humidity	1000Hrs.	85 /85%RH	25pcs	0/1

### 2) Criteria for Judging the Damage:

Item	Symbol	Test Conditions	Criteria for Judgment		
			Min	Мах	
Forward Voltage	VF	IF=20mA		F.V.*)×1.1	
Reverse Current	IR	VR=5V		F.V.*)×2.0	
Luminous Intensity	IV	IF=20mA	F.V.*)×0.7		

\*) F.V.: First Value.



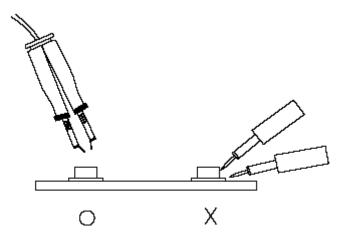
Please read the following notes before using the product: 1. Over-current-proof Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen). 2. Storage 2.1 Do not open moisture proof bag before the products are ready to use. 2.2 Before opening the package, the LEDs should be kept at 30 or less and 90%RH or less. 2.3 The LEDs should be used within a year. 2.4 After opening the package, the LEDs should be kept at 30 or less and 70%RH or less. 2.5 The LEDs should be used within 168 hours (7 days) after opening the package. 2.6 If the moisture adsorbent material (silica gel) has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5 for 24 hours. 3. Soldering Condition 3.1 Pb-free solder temperature profile. 1 ~ 5°C / sec. 260°C Max. 5 sec. Max. Pre-heating  $1 \sim 5^{\circ}C / sec.$  $180 \sim 200^{\circ}C$ 60sec.Max. Above 220° 120sec.Max 3.2 Reflow soldering should not be done more than two times. 3.3 When soldering, do not put stress on the LEDs during heating. 3.4 After soldering, do not warp the circuit board. 4. Soldering Iron Each terminal is to go to the tip of soldering iron temperature less than 260 for 5 seconds

within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.



### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



## 6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.